2SD2136

Silicon NPN triple diffusion planar type

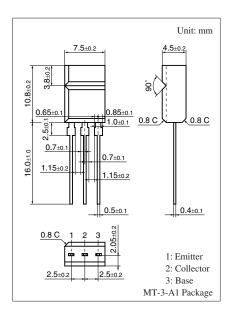
For power amplification Complementary to 2SB1416

■ Features

- \bullet High forward current transfer ratio h_{FE} which has satisfactory linearity.
- \bullet Low collector-emitter saturation voltage $V_{\text{CE}(\text{sat})}$
- Allowing supply with the radial taping

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	V _{CBO}	60	V
Collector-emitter voltage (Base open)	V _{CEO}	60	V
Emitter-base voltage (Collector open)	V_{EBO}	6	V
Collector current	I_C	3	A
Peak collector current	I_{CP}	5	A
Collector power dissipation	P _C	1.5	W
Junction temperature	T_{j}	150	°C
Storage temperature	T _{stg}	-55 to +150	°C



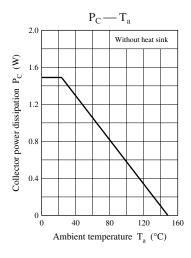
■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

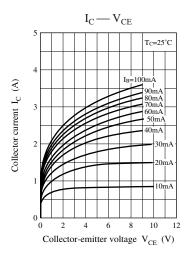
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage (Base open)	V _{CEO}	$I_C = 30 \text{ mA}, I_B = 0$	60			V
Base-emitter voltage *1	V_{BE}	$V_{CE} = 4 \text{ V}, I_{C} = 3 \text{ A}$			1.8	V
Collector-emitter cutoff current (Emitter-base short)	I _{CES}	$V_{CE} = 60 \text{ V}, V_{BE} = 0$			200	μΑ
Collector-emitter cutoff current (Base open)	I_{CEO}	$V_{CE} = 30 \text{ V}, I_{B} = 0$			300	μΑ
Emitter-base cutoff current (Collector open)	I_{EBO}	$V_{EB} = 6 \text{ V}, I_C = 0$			1	mA
Forward current transfer ratio	h _{FE1} *2	$V_{CE} = 4 \text{ V}, I_{C} = 1 \text{ A}$	40		250	_
	h _{FE2} *1	$V_{CE} = 4 \text{ V}, I_{C} = 3 \text{ A}$	10			
Collector-emitter saturation voltage *1	V _{CE(sat)}	$I_C = 3 \text{ A}, I_B = 0.375 \text{ A}$			1.2	V
Transition frequency	f_T	$V_{CE} = 5 \text{ V}, I_{E} = -0.1 \text{ A}, f = 200 \text{ MHz}$		220		MHz
Turn-on time	t _{on}	$I_C = 1 A$, $I_{B1} = 0.1 A$, $I_{B2} = -0.1 A$		0.5		μs
Storage time	t _{stg}			2.5		μs
Fall time	t _f			0.4		μs

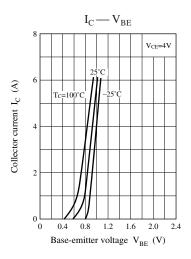
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

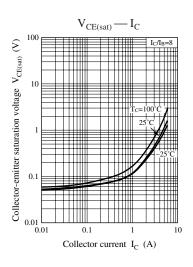
- 2. *1: Pulse measurement
 - *2: Rank classification

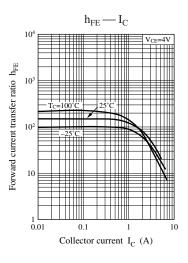
Rank	Р	Q	R
$h_{\rm FE1}$	40 to 90	70 to 150	120 to 250

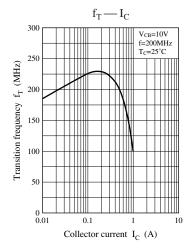


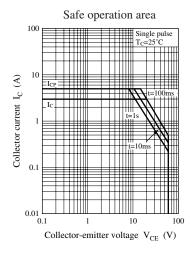


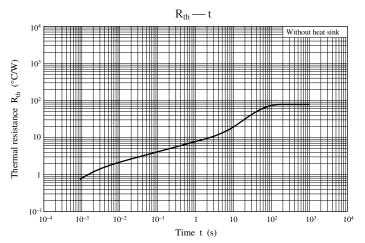












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